# **PCF1179C**

# 4-digit duplex LCD car clock Rev. 3 — 12 February 2015

**Product data sheet** 

#### 1. **General description**

The PCF1179C is a single chip, 4.19 MHz car clock circuit providing hours, minutes, and seconds functions. It is designed to drive a 4-digit duplex liquid crystal display (LCD).

Two external single-pole, single-throw push buttons accomplish all time setting functions. Time calibration and voltage regulator are electrically programmable via an on-chip EEPROM. The circuit is battery-operated via an internal voltage regulator and an external resistor.

### 2. Features and benefits

- Internal voltage regulator is electrically programmable for various LCD voltages
- Time calibration is electrically programmable (no trimming capacitor required)
- LCD voltage adjusts with temperature for a good contrast
- 4.19 MHz oscillator
- 12-hour or 24-hour mode
- Operating ambient temperature: -40 °C to +85 °C
- 28-lead plastic SMD (SO28)
- 4 Hz set mode.

#### **Ordering information** 3.

Table 1. **Ordering information** 

Type number	Package					
	Name	Description	Version			
PCF1179CT	SO28	plastic small outline package; 28 leads; body width 7.5 mm	SOT136-1			

### 3.1 Ordering options

Table 2. **Ordering options** 

Product type number	Orderable part number	Sales item (12NC)	Delivery form	IC revision
PCF1179CT	PCF1179CT,112	935059760112	Tube	1
PCF1179CT	PCF1179CT,118	935059760118	Reel Pack, SMD, 13 inch	1



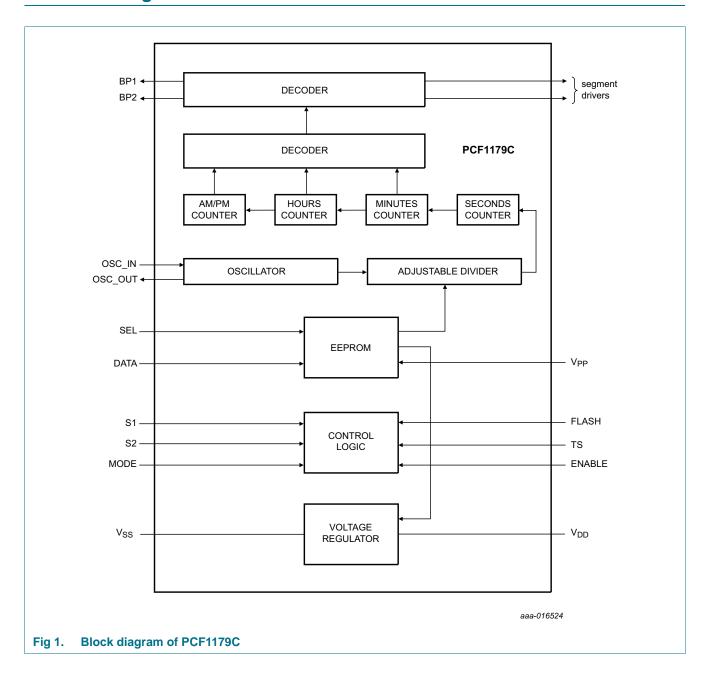
4-digit duplex LCD car clock

### 4. Marking

Table 3. Marking codes

Type number	Marking code
PCF1179CT	PCF1179CT

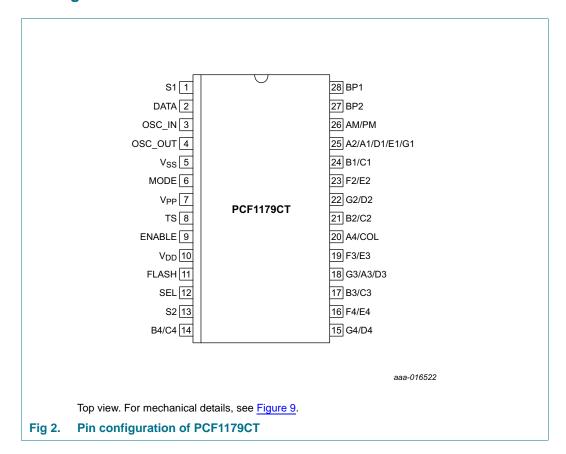
# 5. Block diagram



4-digit duplex LCD car clock

### 6. Pinning information

### 6.1 Pinning



### 4-digit duplex LCD car clock

### 6.2 Pin description

Table 4. Pin description

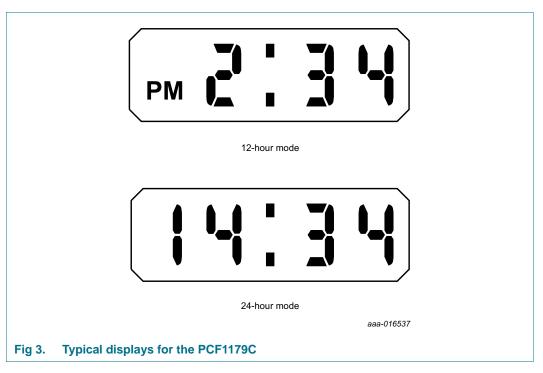
Symbol	Pin	Description	
S1	1	hour adjustment input	
DATA	2	EEPROM data input	
OSC_IN	3	oscillator input	
OSC_OUT	4	oscillator output	
$V_{SS}$	5	negative supply voltage	
MODE	6	12/24-hour mode select input	
$V_{PP}$	7	programming voltage input	
TS	8	test speed-up mode input	
ENABLE	9	enable input (for S1 and S2)	
$V_{DD}$	10	positive supply voltage	
FLASH	11	colon option input	
SEL	12	EEPROM select input	
S2	13	minute adjustment input	
B4/C4	14	segment drivers	
G4/D4	15		
F4/E4	16		
B3/C3	17		
G3/A3/D3	18		
F3/E3	19		
A4/COL	20		
B2/C2	21		
G2/D2	22		
F2/E2	23		
B1/C1	24		
A2/A1/D1/E1/G1	25		
AM/PM	26		
BP2	27	backplane 2	
BP1	28	backplane 1	

4-digit duplex LCD car clock

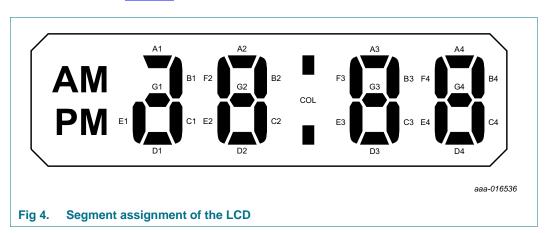
# 7. Functional description

### 7.1 Outputs

Typical displays for the PCF1179C are shown in Figure 3.



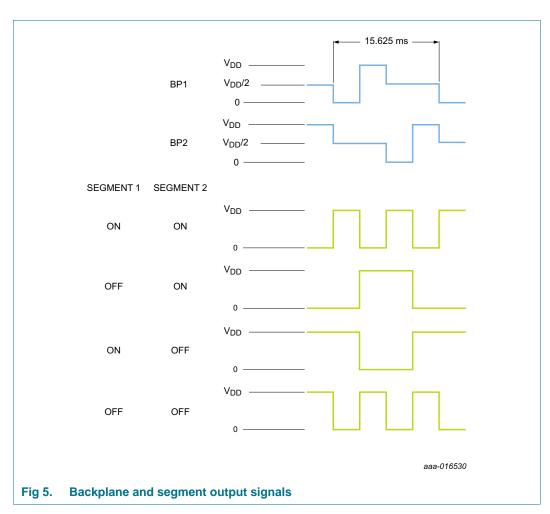
The circuit outputs 1:2 multiplexed data (duplex) to the LCD. The segment assignment of the LCD is show in Figure 4.



### 7.2 LCD voltage

Generation of BP1 and BP2 (three-level backplane signals at  $V_{DD}$ ,  $V_{DD}/2$ , and 0) and the output signals are shown in Figure 5.

4-digit duplex LCD car clock



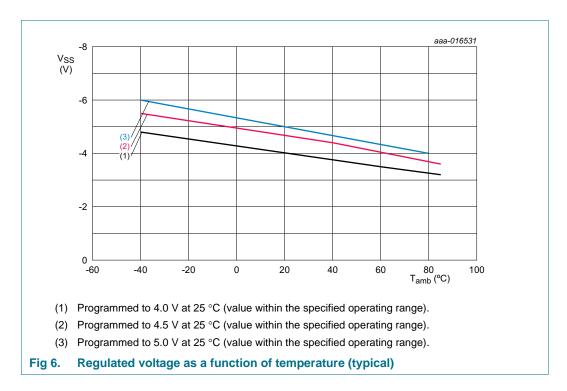
The average voltages across the segments are:

- 1.  $V_{ON(RMS)} = 0.79V_{DD}$
- 2.  $V_{OFF(RMS)} = 0.35V_{DD}$

For a good contrast, the adjustable voltage regulator controls the supply voltage (see <u>Figure 6</u> and <u>Section 7.13</u>) in relation to temperature. For example, when  $V_{DD} = 4.5 \text{ V}$  at +25 °C, then:

- $V_{DD} = 3 \text{ V to 4 V at +85 }^{\circ}\text{C}$
- $V_{DD} = 5 \text{ V to 6 V at } -40 \,^{\circ}\text{C}$

4-digit duplex LCD car clock



#### 7.3 12/24-hour mode

Operation in 12-hour or 24-hour mode is selected by connecting MODE to  $V_{DD}$  or  $V_{SS}$  respectively. If MODE is left open-circuit and a reset occurs, the mode changes from 12-hour to 24-hour mode or vice versa.

### 7.4 Power-on

After connecting the supply, the start-up mode is:

- MODE connected to V<sub>DD</sub>: 12-hour mode, 1:00 AM.
- MODE connected to V<sub>SS</sub>: 24-hour mode, 0:00.
- MODE left open-circuit: 24-hour mode, 0:00 or 1:00.

### 7.5 Colon

If FLASH is connected to V<sub>DD</sub>, the colon pulses at 1 Hz.

If FLASH is connected to V<sub>SS</sub>, the colon is static.

### 7.6 Time setting

The push button inputs S1 and S2 have a pull-up resistor to facilitate the use of single-pole, single-throw contacts. A debounce circuit is incorporated to protect against contact bounce and parasitic voltages.

### 7.7 Set enable

Inputs S1 and S2 are enabled by connecting ENABLE to  $V_{DD}$  or disabled by connecting it to  $V_{SS}$ .

PCF1179C

4-digit duplex LCD car clock

#### 7.8 Set hours

When S1 is connected to V<sub>SS</sub>, the hours displayed advances by one and after one second it continues with four advances per second until S1 is released (auto-increment).

#### 7.9 Set minutes

When S2 is connected to V<sub>SS</sub>, the time displayed in minutes advances by one and after one second it continues with four advances per second until S2 is released (auto-increment). In addition to the minute correction, the seconds counter is reset to zero. Overflow in the minute counter does not have an influence on the hour counter.

### 7.10 Segment test/reset

When S1 and S2 are connected to  $V_{SS}$ , all LCD segments are switched ON. Releasing push buttons S1 and S2 resets the display. No reset occurs when DATA is connected to  $V_{SS}$  (overlapping S1 and S2).

#### 7.11 Test mode

When TS is connected to  $V_{DD}$ , the device is in normal operating mode. When connecting TS to  $V_{SS}$ , all counters (seconds, minutes, and hours) are stopped, allowing quick testing of the display via S1 and S2 (debounce and auto-increment times are 64 times faster). TS has a pull-up resistor but for reasons of safety it should be connected to  $V_{DD}$ .

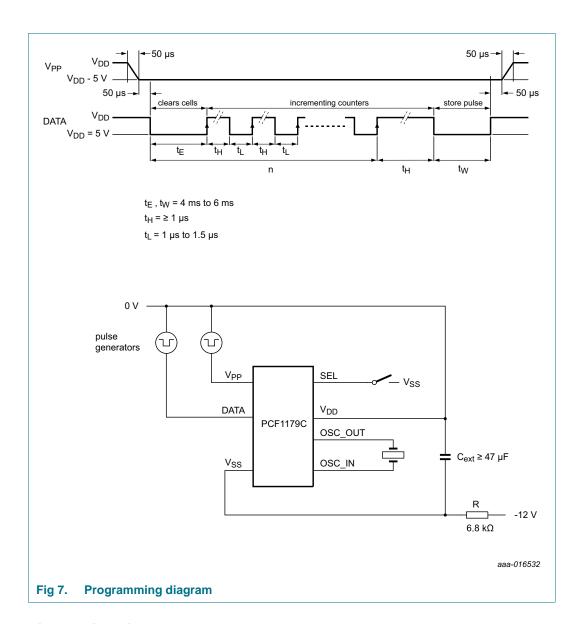
#### 7.12 EEPROM

 $V_{PP}$  has a pull-up resistor but for reasons of safety it should be connected to  $V_{DD}$ .

### 7.13 LCD voltage programming

To enable LCD voltage programming, SEL is set to open-circuit and a level of  $V_{DD}-5\ V$  is applied to  $V_{PP},$  see Figure 7. The first pulse  $(t_E)$  applied to the DATA input clears the EEPROM to give the lowest voltage output. Further pulses  $(t_L)$  increment the output voltage by steps of typically 150 mV  $(T_{amb}=25\ ^{\circ}C).$  For programming, measure  $V_{DD}-V_{SS}$  and apply a store pulse  $(t_W)$  when the required value is reached. If the maximum number of steps (n=31) is reached and an additional pulse is applied the voltage returns to the lowest value.

### 4-digit duplex LCD car clock



### 7.14 Time calibration

To compensate for the tolerance in the quartz crystal frequency which has been positively offset (nominal deviation  $+60 \times 10^{-6}$ ) by capacitors at the oscillator input and output, a number (n) of 262 144 Hz pulses are inhibited every second of operation.

The number (n) is stored in a non-volatile memory which is achieved by the following steps, see Figure 7:

- 1. Set SEL to  $V_{SS}$  and a level of  $V_{DD}$  5 V to  $V_{PP}$
- 2. The quartz-frequency deviation Δf/f is measured and (n) is calculated (see Table 5)
- 3. A first pulse, t<sub>E</sub>, is applied to the DATA input. It clears the EEPROM to give the highest backplane frequency
- 4. The calculated pulses (n) are entered in  $(t_H, t_L)$ . If the maximum backplane period is reached and an additional pulse is applied, the period returns to the lowest value.

PCF1179C

### 4-digit duplex LCD car clock

- 5. The backplane period is controlled and then correctly fixed by applying the store pulse  $t_{\rm W}$
- 6. Release SEL and  $V_{\mbox{\footnotesize{PP}}}$ .

Table 5. Time calibration

 $\Delta t = 7.63 \ \mu s$ ; SEL at V<sub>SS</sub>.

Oscillator-frequency deviation∆f/f (× 10 <sup>-6</sup> )	Number of pulses (n)	Backplane period (ms)
0	0	15.625
+3.8	1	15.633
+7.6	2	15.641
+11.4	3	15.648
:	:	:
+117.8	31	15.861

4-digit duplex LCD car clock

### 8. Safety notes

#### **CAUTION**



This device is sensitive to ElectroStatic Discharge (ESD). Observe precautions for handling electrostatic sensitive devices.

Such precautions are described in the ANSI/ESD S20.20, IEC/ST 61340-5, JESD625-A or equivalent standards.

# 9. Limiting values

#### Table 6. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions		Min	Max	Unit
$V_{DD}$	supply voltage	with respect to V <sub>SS</sub>		-	8	V
I <sub>DD</sub>	supply current	V <sub>SS</sub> = 0 V	[1]	-	3	mA
VI	input voltage	all pins except V <sub>PP</sub> , DATA		-0.3	V <sub>DD</sub> + 0.3	V
		pins V <sub>PP</sub> , DATA		-3	V <sub>DD</sub> + 0.3	V
V <sub>ESD</sub>	electrostatic discharge voltage	НВМ	[2]	-	±2000	V
l <sub>lu</sub>	latch-up current		[3]	-	100	mA
T <sub>stg</sub>	storage temperature		[4]	-55	+125	°C
T <sub>amb</sub>	ambient temperature	operating device		-40	+85	°C

<sup>[1]</sup> Connecting the supply voltage with reverse polarity, does not harm the circuit, provided the current is limited to 10 mA by an external resistor.

<sup>[2]</sup> Pass level; Human Body Model (HBM), according to Ref. 6 "JESD22-A114".

<sup>[3]</sup> Pass level; latch-up testing according to Ref. 7 "JESD78" at maximum ambient temperature (T<sub>amb(max)</sub>).

<sup>[4]</sup> According to the store and transport requirements (see Ref. 10 "UM10569") the devices have to be stored at a temperature of +8 °C to +45 °C and a humidity of 25 % to 75 %.

4-digit duplex LCD car clock

### 10. Characteristics

### Table 7. Characteristics

 $V_{DD}=3~V$  to 6 V;  $V_{SS}=0~V$ ;  $T_{amb}=-40~^{\circ}C$  to +85  $^{\circ}C$ ; crystal: f=4.194304~MHz;  $R_{s}=50~\Omega$ ;  $C_{L}=12~pF$ ; maximum frequency tolerance  $=\pm30\times10^{-6}$ ; unless otherwise specified.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Supply						'
$V_{DD}$	supply voltage	voltage regulator programmed to 4.5 V at T <sub>amb</sub> = 25 °C	3	-	6	V
$\Delta V_{DD}$	supply voltage variation	S1 or S2 closed	-	-	50	mV
TC	supply voltage variation		-	-0.35	-	%/K
	due to temperature	V <sub>DD</sub> = 4.5 V	-	-16	-	mV/K
I <sub>DD</sub>	supply current	[1]	700	950	-	μΑ
C <sub>EXT</sub>	capacitance	external capacitor	47	-	-	μF
Oscillator						
t <sub>osc</sub>	start time		-	-	200	ms
Δf/f	frequency deviation	nominal n = 0	0	60 × 10 <sup>-6</sup>	110 × 10 <sup>-6</sup>	-
Δf/f	frequency stability	$\Delta V_{DD} = 100 \text{ mV}$	-	-	1 × 10 <sup>-6</sup>	-
R <sub>fb</sub>	feedback resistance		300	1000	3000	kΩ
Ci	input capacitance		-	16	-	pF
Co	output capacitance		-	27	-	pF
Inputs				1		
R <sub>O</sub>	pull-up resistance	S1, S2, TS, SEL, DATA	45	90	180	kΩ
R <sub>O</sub>	pull-up/pull-down resistance	MODE	100	300	1000	kΩ
I <sub>IL</sub>	leakage current	ENABLE, FLASH	-	-	2	μА
t <sub>d</sub>	debounce time	S1 and S2 only	30	65	100	ms
V <sub>PP</sub> progra	amming voltage					
I <sub>O2</sub>	output current	$V_{PP} = V_{DD} - 5 V$	70	-	700	μА
		during programming	-	500	-	μА
Backplane	(HIGH and LOW levels)					
R <sub>BP</sub>	output resistance	±100 μA	-	-	3	kΩ
Segment					,	
R <sub>SEG</sub>	output resistance	±100 μA	-	-	5	kΩ
LCD	1			1	1	1
V <sub>offset(DC)</sub>	DC offset voltage	200 kΩ/1 nF	-	-	50	mV

<sup>[1]</sup> A suitable resistor (R) must be selected (example):

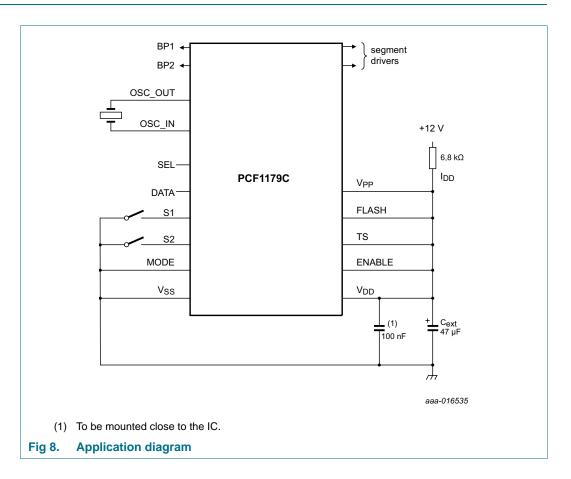
a)  $V_{DD}$  = 5 V;  $R_{max}$  = (12 V - 5 V)/700  $\mu A$  = 10  $k\Omega.$ 

b)  $V_{DD}$  = 5 V;  $R_{typ}$  = (12 V - 5 V)/1000  $\mu A$  = 7  $k\Omega$  (1000  $\mu A,$  to have more reserve).

c)  $I_{DD}$  must not exceed 3 mA.

4-digit duplex LCD car clock

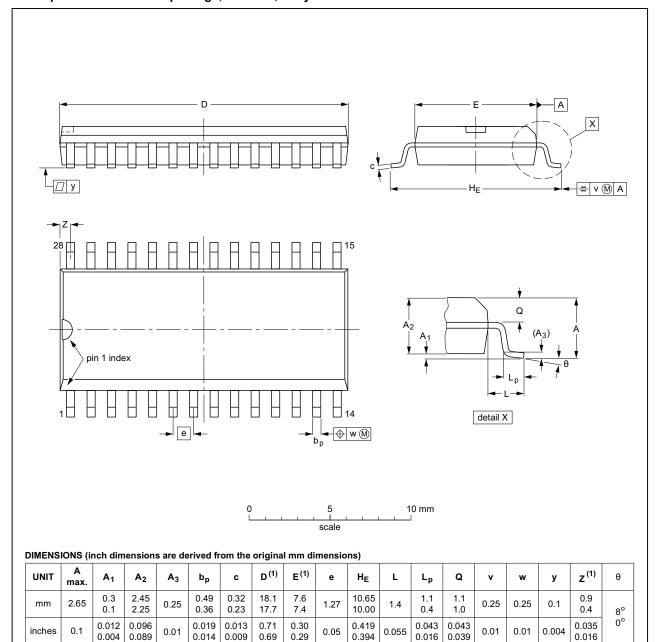
# 11. Application information



### 12. Package outline

### SO28: plastic small outline package; 28 leads; body width 7.5 mm

SOT136-1



#### Note

1. Plastic or metal protrusions of 0.15 mm (0.006 inch) maximum per side are not included.

OUTLINE	REFERENCES				EUROPEAN	ISSUE DATE
VERSION	IEC	JEDEC	JEITA		PROJECTION ISSUE DATE	
SOT136-1	075E06	MS-013				<del>99-12-27</del> 03-02-19

Fig 9. Package outline SOT136-1 (SO28) of PCF1179CT

PCF1179C

4-digit duplex LCD car clock

### 13. Packing information

### 13.1 Tape and reel information

For tape and reel packing information, see Ref. 9 "SOT136-1\_118" on page 19.

### 14. Soldering of SMD packages

This text provides a very brief insight into a complex technology. A more in-depth account of soldering ICs can be found in Application Note *AN10365* "Surface mount reflow soldering description".

### 14.1 Introduction to soldering

Soldering is one of the most common methods through which packages are attached to Printed Circuit Boards (PCBs), to form electrical circuits. The soldered joint provides both the mechanical and the electrical connection. There is no single soldering method that is ideal for all IC packages. Wave soldering is often preferred when through-hole and Surface Mount Devices (SMDs) are mixed on one printed wiring board; however, it is not suitable for fine pitch SMDs. Reflow soldering is ideal for the small pitches and high densities that come with increased miniaturization.

### 14.2 Wave and reflow soldering

Wave soldering is a joining technology in which the joints are made by solder coming from a standing wave of liquid solder. The wave soldering process is suitable for the following:

- Through-hole components
- Leaded or leadless SMDs, which are glued to the surface of the printed circuit board

Not all SMDs can be wave soldered. Packages with solder balls, and some leadless packages which have solder lands underneath the body, cannot be wave soldered. Also, leaded SMDs with leads having a pitch smaller than ~0.6 mm cannot be wave soldered, due to an increased probability of bridging.

The reflow soldering process involves applying solder paste to a board, followed by component placement and exposure to a temperature profile. Leaded packages, packages with solder balls, and leadless packages are all reflow solderable.

Key characteristics in both wave and reflow soldering are:

- Board specifications, including the board finish, solder masks and vias
- Package footprints, including solder thieves and orientation
- The moisture sensitivity level of the packages
- Package placement
- Inspection and repair
- Lead-free soldering versus SnPb soldering

### 14.3 Wave soldering

Key characteristics in wave soldering are:

PCF1179C

4-digit duplex LCD car clock

- Process issues, such as application of adhesive and flux, clinching of leads, board transport, the solder wave parameters, and the time during which components are exposed to the wave
- Solder bath specifications, including temperature and impurities

### 14.4 Reflow soldering

Key characteristics in reflow soldering are:

- Lead-free versus SnPb soldering; note that a lead-free reflow process usually leads to higher minimum peak temperatures (see <u>Figure 10</u>) than a SnPb process, thus reducing the process window
- Solder paste printing issues including smearing, release, and adjusting the process window for a mix of large and small components on one board
- Reflow temperature profile; this profile includes preheat, reflow (in which the board is heated to the peak temperature) and cooling down. It is imperative that the peak temperature is high enough for the solder to make reliable solder joints (a solder paste characteristic). In addition, the peak temperature must be low enough that the packages and/or boards are not damaged. The peak temperature of the package depends on package thickness and volume and is classified in accordance with Table 8 and 9

Table 8. SnPb eutectic process (from J-STD-020D)

Package thickness (mm)	Package reflow temperature (°C)		
	Volume (mm³)		
	< 350	≥ 350	
< 2.5	235	220	
≥ 2.5	220	220	

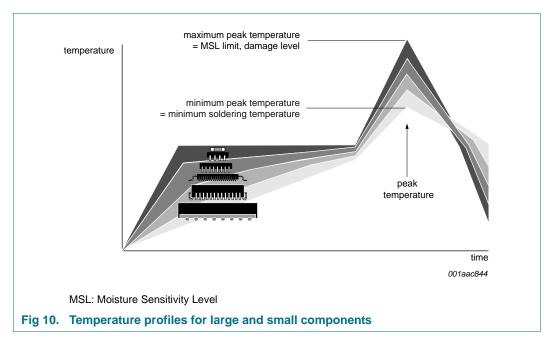
Table 9. Lead-free process (from J-STD-020D)

Package thickness (mm)	Package reflow temperature (°C)				
	Volume (mm³)				
	< 350 350 to 2000 > 2000				
< 1.6	260	260	260		
1.6 to 2.5	260	250	245		
> 2.5	250	245	245		

Moisture sensitivity precautions, as indicated on the packing, must be respected at all times.

Studies have shown that small packages reach higher temperatures during reflow soldering, see Figure 10.

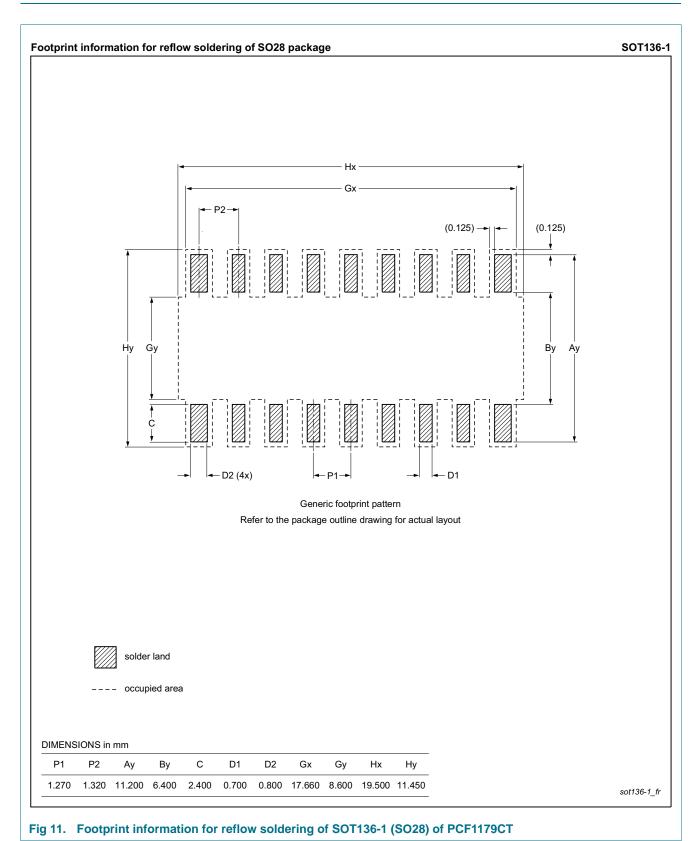
### 4-digit duplex LCD car clock



For further information on temperature profiles, refer to Application Note *AN10365* "Surface mount reflow soldering description".

4-digit duplex LCD car clock

### 15. Soldering: Footprint information



### 4-digit duplex LCD car clock

### 16. References

- [1] AN10365 Surface mount reflow soldering description
- [2] AN10853 ESD and EMC sensitivity of IC
- [3] IEC 60134 Rating systems for electronic tubes and valves and analogous semiconductor devices
- [4] IEC 61340-5 Protection of electronic devices from electrostatic phenomena
- [5] IPC/JEDEC J-STD-020D Moisture/Reflow Sensitivity Classification for Nonhermetic Solid State Surface Mount Devices
- [6] JESD22-A114 Electrostatic Discharge (ESD) Sensitivity Testing Human Body Model (HBM)
- [7] JESD78 IC Latch-Up Test
- [8] **JESD625-A** Requirements for Handling Electrostatic-Discharge-Sensitive (ESDS) Devices
- [9] SOT136-1\_118 SO28; Reel dry pack; SMD, 13", packing information
- [10] UM10569 Store and transport requirements

4-digit duplex LCD car clock

# 17. Revision history

### Table 10. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes	
PCF1179C v.3	20150212	Product data sheet	-	PCF1179C v.2	
Modifications:		<ul> <li>The format of this data sheet has been redesigned to comply with the new identity guidelines of NXP Semiconductors.</li> </ul>			
	<ul> <li>Legal texts have been adapted to the new company name where appropriate.</li> </ul>				
	Removed obsolete product types				
	Fixed typos				

4-digit duplex LCD car clock

### 18. Legal information

#### 18.1 Data sheet status

Document status[1][2]	Product status[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

- [1] Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions"
- [3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL http://www.nxp.com.

#### 18.2 Definitions

Draft — The document is a draft version only. The content is still under internal review and subject to formal approval, which may result in modifications or additions. NXP Semiconductors does not give any representations or warranties as to the accuracy or completeness of information included herein and shall have no liability for the consequences of use of such information.

Short data sheet — A short data sheet is an extract from a full data sheet with the same product type number(s) and title. A short data sheet is intended for quick reference only and should not be relied upon to contain detailed and full information. For detailed and full information see the relevant full data sheet, which is available on request via the local NXP Semiconductors sales office. In case of any inconsistency or conflict with the short data sheet, the full data sheet shall prevail.

**Product specification** — The information and data provided in a Product data sheet shall define the specification of the product as agreed between NXP Semiconductors and its customer, unless NXP Semiconductors and customer have explicitly agreed otherwise in writing. In no event however, shall an agreement be valid in which the NXP Semiconductors product is deemed to offer functions and qualities beyond those described in the Product data sheet.

#### 18.3 Disclaimers

Limited warranty and liability — Information in this document is believed to be accurate and reliable. However, NXP Semiconductors does not give any representations or warranties, expressed or implied, as to the accuracy or completeness of such information and shall have no liability for the consequences of use of such information. NXP Semiconductors takes no responsibility for the content in this document if provided by an information source outside of NXP Semiconductors.

In no event shall NXP Semiconductors be liable for any indirect, incidental, punitive, special or consequential damages (including - without limitation - lost profits, lost savings, business interruption, costs related to the removal or replacement of any products or rework charges) whether or not such damages are based on tort (including negligence), warranty, breach of contract or any other legal theory.

Notwithstanding any damages that customer might incur for any reason whatsoever, NXP Semiconductors' aggregate and cumulative liability towards customer for the products described herein shall be limited in accordance with the *Terms and conditions of commercial sale* of NXP Semiconductors.

Right to make changes — NXP Semiconductors reserves the right to make changes to information published in this document, including without limitation specifications and product descriptions, at any time and without notice. This document supersedes and replaces all information supplied prior to the publication hereof.

Suitability for use — NXP Semiconductors products are not designed, authorized or warranted to be suitable for use in life support, life-critical or safety-critical systems or equipment, nor in applications where failure or malfunction of an NXP Semiconductors product can reasonably be expected to result in personal injury, death or severe property or environmental damage. NXP Semiconductors and its suppliers accept no liability for inclusion and/or use of NXP Semiconductors products in such equipment or applications and therefore such inclusion and/or use is at the customer's own risk

**Applications** — Applications that are described herein for any of these products are for illustrative purposes only. NXP Semiconductors makes no representation or warranty that such applications will be suitable for the specified use without further testing or modification.

Customers are responsible for the design and operation of their applications and products using NXP Semiconductors products, and NXP Semiconductors accepts no liability for any assistance with applications or customer product design. It is customer's sole responsibility to determine whether the NXP Semiconductors product is suitable and fit for the customer's applications and products planned, as well as for the planned application and use of customer's third party customer(s). Customers should provide appropriate design and operating safeguards to minimize the risks associated with their applications and products.

NXP Semiconductors does not accept any liability related to any default, damage, costs or problem which is based on any weakness or default in the customer's applications or products, or the application or use by customer's third party customer(s). Customer is responsible for doing all necessary testing for the customer's applications and products using NXP Semiconductors products in order to avoid a default of the applications and the products or of the application or use by customer's third party customer(s). NXP does not accept any liability in this respect.

Limiting values — Stress above one or more limiting values (as defined in the Absolute Maximum Ratings System of IEC 60134) will cause permanent damage to the device. Limiting values are stress ratings only and (proper) operation of the device at these or any other conditions above those given in the Recommended operating conditions section (if present) or the Characteristics sections of this document is not warranted. Constant or repeated exposure to limiting values will permanently and irreversibly affect the quality and reliability of the device.

Terms and conditions of commercial sale — NXP Semiconductors products are sold subject to the general terms and conditions of commercial sale, as published at <a href="http://www.nxp.com/profile/terms">http://www.nxp.com/profile/terms</a>, unless otherwise agreed in a valid written individual agreement. In case an individual agreement is concluded only the terms and conditions of the respective agreement shall apply. NXP Semiconductors hereby expressly objects to applying the customer's general terms and conditions with regard to the purchase of NXP Semiconductors products by customer.

**No offer to sell or license** — Nothing in this document may be interpreted or construed as an offer to sell products that is open for acceptance or the grant, conveyance or implication of any license under any copyrights, patents or other industrial or intellectual property rights.

PCF1179C

All information provided in this document is subject to legal disclaimers.

© NXP Semiconductors N.V. 2015. All rights reserved.

### 4-digit duplex LCD car clock

**Export control** — This document as well as the item(s) described herein may be subject to export control regulations. Export might require a prior authorization from competent authorities.

**Quick reference data** — The Quick reference data is an extract of the product data given in the Limiting values and Characteristics sections of this document, and as such is not complete, exhaustive or legally binding.

Non-automotive qualified products — Unless this data sheet expressly states that this specific NXP Semiconductors product is automotive qualified, the product is not suitable for automotive use. It is neither qualified nor tested in accordance with automotive testing or application requirements. NXP Semiconductors accepts no liability for inclusion and/or use of non-automotive qualified products in automotive equipment or applications.

In the event that customer uses the product for design-in and use in automotive applications to automotive specifications and standards, customer (a) shall use the product without NXP Semiconductors' warranty of the product for such automotive applications, use and specifications, and (b) whenever customer uses the product for automotive applications beyond NXP Semiconductors' specifications such use shall be solely at customer's own risk, and (c) customer fully indemnifies NXP Semiconductors for any liability, damages or failed product claims resulting from customer design and use of the product for automotive applications beyond NXP Semiconductors' standard warranty and NXP Semiconductors' product specifications.

**Translations** — A non-English (translated) version of a document is for reference only. The English version shall prevail in case of any discrepancy between the translated and English versions.

Bare die — All die are tested on compliance with their related technical specifications as stated in this data sheet up to the point of wafer sawing and are handled in accordance with the NXP Semiconductors storage and transportation conditions. If there are data sheet limits not guaranteed, these will be separately indicated in the data sheet. There are no post-packing tests performed on individual die or wafers.

NXP Semiconductors has no control of third party procedures in the sawing, handling, packing or assembly of the die. Accordingly, NXP Semiconductors assumes no liability for device functionality or performance of the die or systems after third party sawing, handling, packing or assembly of the die. It is the responsibility of the customer to test and qualify their application in which the die is used.

All die sales are conditioned upon and subject to the customer entering into a written die sale agreement with NXP Semiconductors through its legal department.

#### 18.4 Trademarks

Notice: All referenced brands, product names, service names and trademarks are the property of their respective owners.

I<sup>2</sup>C-bus — logo is a trademark of NXP Semiconductors N.V.

### 19. Contact information

For more information, please visit: http://www.nxp.com

For sales office addresses, please send an email to: salesaddresses@nxp.com

### 4-digit duplex LCD car clock

### 20. Tables

Table 1.	Ordering information1
Table 2.	Ordering options1
Table 3.	Marking codes2
Table 4.	Pin description
Table 5.	Time calibration
Table 6.	Limiting values
Table 7.	Characteristics
Table 8.	SnPb eutectic process (from J-STD-020D)16
Table 9.	Lead-free process (from J-STD-020D)16
Table 10.	Revision history

### 4-digit duplex LCD car clock

# 21. Figures

Fig 1.	Block diagram of PCF1179C
Fig 2.	Pin configuration of PCF1179CT3
Fig 3.	Typical displays for the PCF1179C 5
Fig 4.	Segment assignment of the LCD5
Fig 5.	Backplane and segment output signals 6
Fig 6.	Regulated voltage as a function of temperature
	(typical)
Fig 7.	Programming diagram
Fig 8.	Application diagram
Fig 9.	Package outline SOT136-1 (SO28) of
	PCF1179CT14
Fig 10.	Temperature profiles for large and small
	components
Fig 11.	Footprint information for reflow soldering of
	SOT136-1 (SO28) of PCF1179CT18

**PCF1179C NXP Semiconductors** 

### 4-digit duplex LCD car clock

### 22. Contents

1	General description
2	
_	Features and benefits
3	Ordering information
3.1	Ordering options
4	Marking 2
5	Block diagram 2
6	Pinning information 3
6.1	Pinning
6.2	Pin description 4
7	Functional description 5
7.1	Outputs 5
7.2	LCD voltage 5
7.3	12/24-hour mode
7.4	Power-on
7.5	Colon
7.6	Time setting
7.7	Set enable
7.8	Set hours
7.9	Set minutes 8
7.10	Segment test/reset
7.11	Test mode
7.12	EEPROM
7.13	LCD voltage programming 8
7.14	Time calibration
8	Safety notes
9	Limiting values
10	<b>Characteristics</b>
11	Application information
12	Package outline
13	Packing information
13.1	Tape and reel information
14	Soldering of SMD packages
14.1	Introduction to soldering
14.2	Wave and reflow soldering 15
14.3	Wave soldering
14.4	Reflow soldering
15	Soldering: Footprint information 18
16	References
17	Revision history
18	Legal information
18.1	Data sheet status
18.2	Definitions
18.3	Disclaimers
18.4	Trademarks

Contact information	22
Tables	23
Figures	24
Contents	25

Please be aware that important notices concerning this document and the product(s) described herein, have been included in section 'Legal information'.



Компания «ЭлектроПласт» предлагает заключение долгосрочных отношений при поставках импортных электронных компонентов на взаимовыгодных условиях!

#### Наши преимущества:

- Оперативные поставки широкого спектра электронных компонентов отечественного и импортного производства напрямую от производителей и с крупнейших мировых складов;
- Поставка более 17-ти миллионов наименований электронных компонентов;
- Поставка сложных, дефицитных, либо снятых с производства позиций;
- Оперативные сроки поставки под заказ (от 5 рабочих дней);
- Экспресс доставка в любую точку России;
- Техническая поддержка проекта, помощь в подборе аналогов, поставка прототипов;
- Система менеджмента качества сертифицирована по Международному стандарту ISO 9001:
- Лицензия ФСБ на осуществление работ с использованием сведений, составляющих государственную тайну;
- Поставка специализированных компонентов (Xilinx, Altera, Analog Devices, Intersil, Interpoint, Microsemi, Aeroflex, Peregrine, Syfer, Eurofarad, Texas Instrument, Miteq, Cobham, E2V, MA-COM, Hittite, Mini-Circuits, General Dynamics и др.);

Помимо этого, одним из направлений компании «ЭлектроПласт» является направление «Источники питания». Мы предлагаем Вам помощь Конструкторского отдела:

- Подбор оптимального решения, техническое обоснование при выборе компонента;
- Подбор аналогов;
- Консультации по применению компонента;
- Поставка образцов и прототипов;
- Техническая поддержка проекта;
- Защита от снятия компонента с производства.



#### Как с нами связаться

**Телефон:** 8 (812) 309 58 32 (многоканальный)

Факс: 8 (812) 320-02-42

Электронная почта: <u>org@eplast1.ru</u>

Адрес: 198099, г. Санкт-Петербург, ул. Калинина,

дом 2, корпус 4, литера А.